

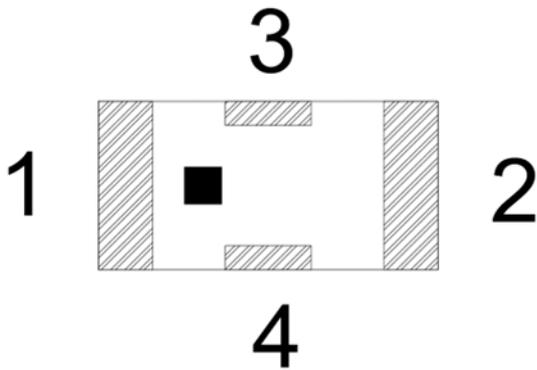
Features

- Multilayer monolithic construction yields high reliability
- Low insertion loss and small size SMD chip design
- Can simplify your complex tuning and circuit design
- LTCC process

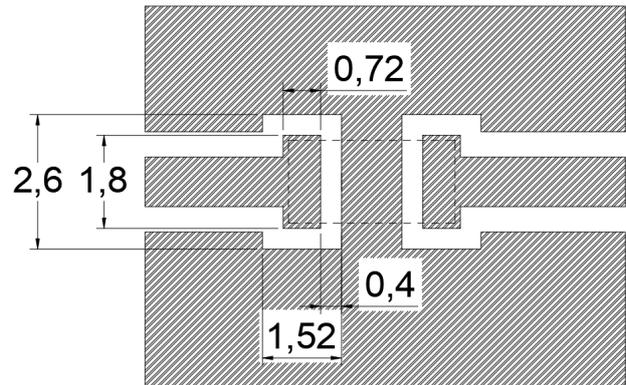
Specifications

NO.	Parameter	Frequency (MHz)	SPEC		
			Min.	Typ	Max.
1	Insertion Loss (dB)	DC~3800	-	-	1.0
2	VSWR	DC~500	-	-	1.5
3	Attenuation (dB)	7000	10	-	-
4	In/Output Impedance (Ω)		50		

Construction



Mounting Considerations

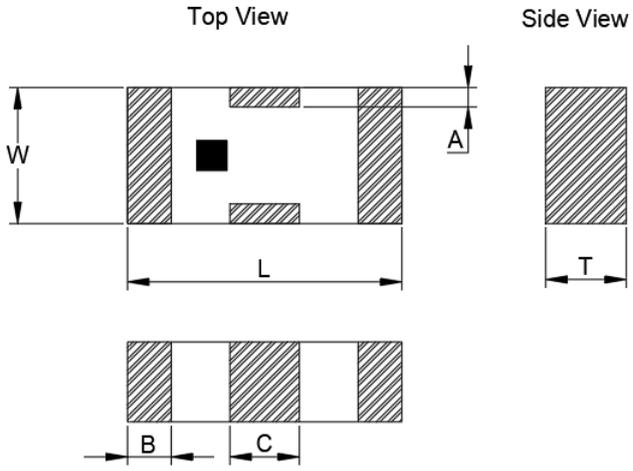


Unit: mm

Line width to be designed to match 50 Ω characteristic impedance, depending on PCB material and thickness

PIN	Connection
1	Input Port
2	Output Port
3	GND
4	GND

Dimensions

	L	3.20±0.20
	W	1.60±0.20
	T	0.94±0.10
	A	0.23±0.10
	B	0.51±0.10
	C	0.81±0.10